



SS52~SS510

Surface Mount Schottky Rectifiers

Major Ratings and Characteristics

I _{F(AV)}	5.0 A
V _{RRM}	20 V to 100 V
I _{FSM}	150 A
V _F	0.50V, 0.55 V, 0.70 V, 0.85V
T _j max.	125 °C



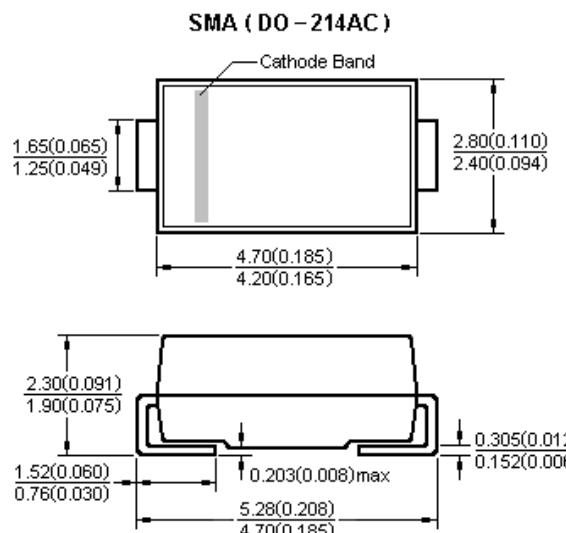
SMA (DO-214AC)

Features

- Low profile package
- Ideal for automated placement
- Ultrafast reverse recovery time
- Low power losses, high efficiency
- Low forward voltage drop
- High surge capability
- High temperature soldering:
260 °C/10 seconds at terminals
- Component in accordance to
RoHS 2002/95/EC and WEEE 2002/96/EC

Mechanical Data

- **Case:** JEDEC DO-214AC molded plastic body over passivated chip
- **Terminals:** Solder plated, solderable per J-STD-002B and JESD22-B102D
- **Polarity:** Laser band denotes cathode end



Dimensions in millimeters and (inches)

Maximum Ratings & Thermal Characteristics & Electrical Characteristics

(T_A = 25 °C unless otherwise noted)

	Symbol	SS52	SS53	SS54	SS55	SS56	SS58	SS510	UNIT
Maximum repetitive peak reverse voltage	V _{RRM}	20	30	40	50	60	80	100	V
Maximum RMS voltage	V _{RMS}	14	21	28	35	42	56	70	V
Maximum DC blocking voltage	V _{DC}	20	30	40	50	60	80	100	V
Maximum average forward rectified current	I _{F(AV)}	5						A	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	150						A	
Maximum instantaneous forward voltage at 5.0A	V _F	0.50	0.55	0.70	0.85				V
Maximum DC reverse current T _A = 25 °C at Rated DC blocking voltage T _A = 100 °C	I _R	0.5				10			
Thermal resistance from junction to Lead	R _{θJL}	35						°C/W	
Operating junction and storage temperature range	T _j , T _{STG}	-65 to +125						°C	

Note 1: Units mounted on P.C.B. 5.0×5.0 mm (0.013 mm thick) land areas



Characteristic Curves ($T_A=25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

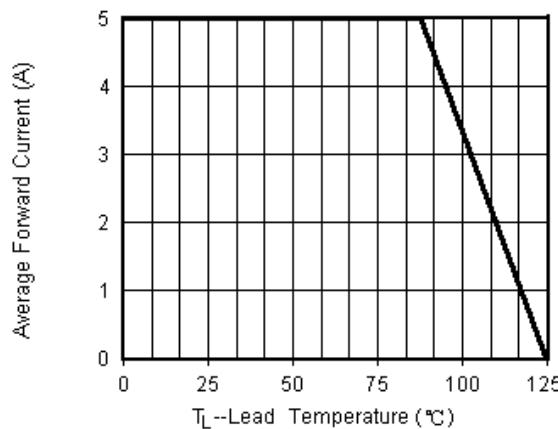


Fig.2 Maximum Non-Repetitive Peak Forward Surge Current

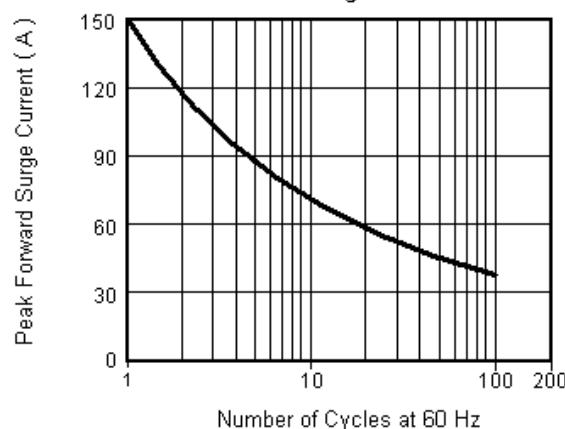


Fig.3 Typical Instantaneous Forward Characteristics

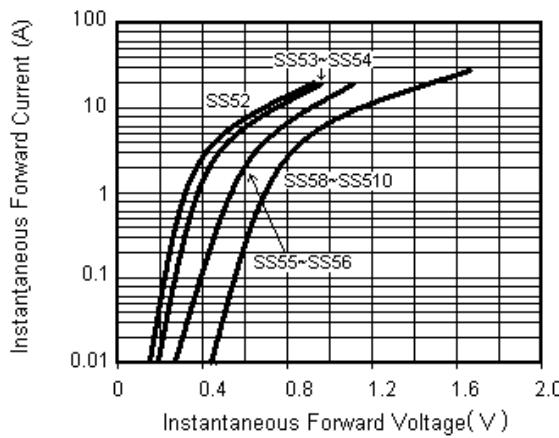


Fig.4 Typical Reverse Leakage Characteristics

